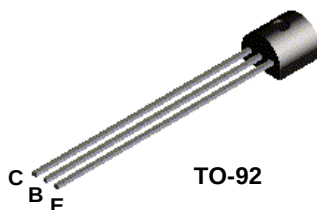


2N5400



PNP General Purpose Amplifier

This device is designed for use as general purpose amplifiers and switches requiring high voltages.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	120	V
V _{CBO}	Collector-Base Voltage	130	V
V _{EBO}	Emitter-Base Voltage	5.0	V
I _C	Collector Current - Continuous	600	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		2N5400	
P _D	Total Device Dissipation Derate above 25°C	625 5.0	mW mW/°C
R _{θJC}	Thermal Resistance, Junction to Case	83.3	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	200	°C/W

PNP General Purpose Amplifier
(continued)

Electrical Characteristics T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
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OFF CHARACTERISTICS

V _{(BR)CEO}	Collector-Emitter Breakdown Voltage*	I _C = 1.0 mA, I _B = 0	120		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	I _C = 100 μA, I _E = 0	130		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	I _E = 10 μA, I _C = 0	5.0		V
I _{CBO}	Collector Cutoff Current	V _{CB} = 100 V, I _E = 0 V _{CB} = 100 V, I _E = 0, T _A = 100 °C		100 100	nA μA
I _{EBO}	Emitter Cutoff Current	V _{EB} = 3.0 V, I _C = 0		50	nA

ON CHARACTERISTICS*

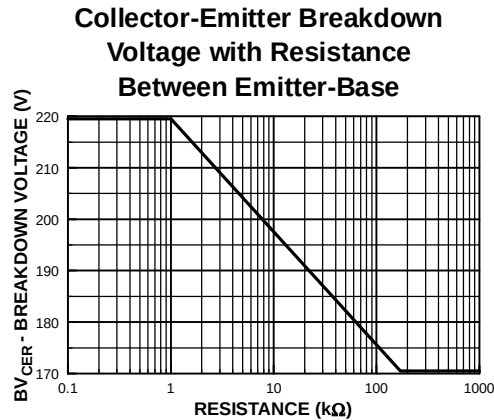
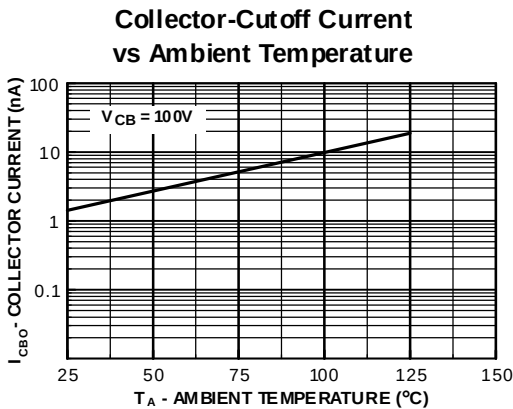
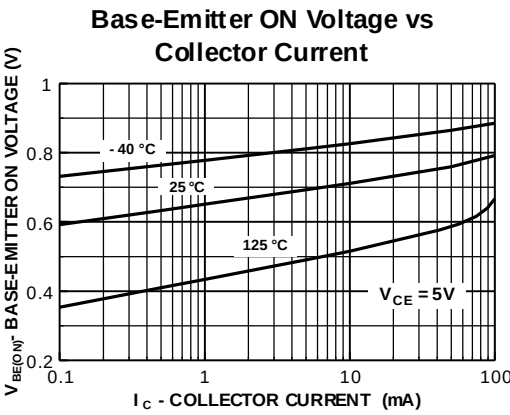
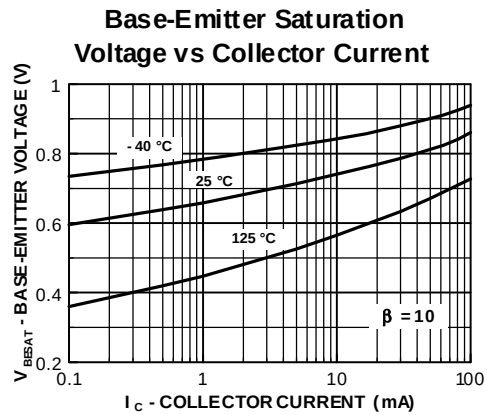
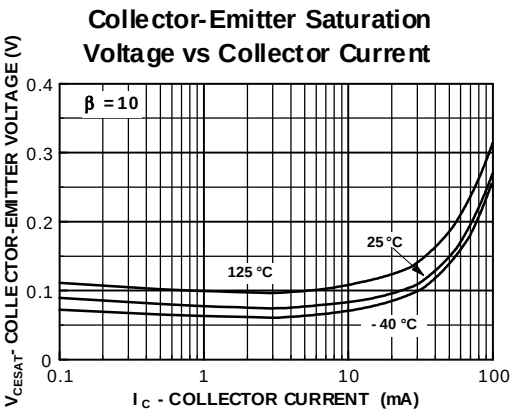
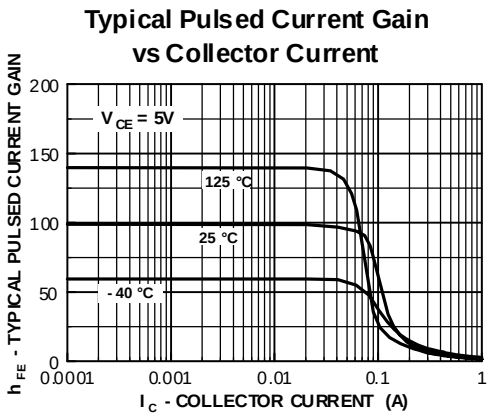
h _{FE}	DC Current Gain	V _{CE} = 5.0 V, I _C = 1.0 mA V _{CE} = 5.0 V, I _C = 10 mA V _{CE} = 5.0 V, I _C = 50 mA	30 40 40	180	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 10 mA, I _B = 1.0 mA I _C = 50 mA, I _B = 5.0 mA		0.2 0.5	V V
V _{BE(sat)}	Base-Emitter Saturation Voltage	I _C = 10 mA, I _B = 1.0 mA I _C = 50 mA, I _B = 5.0 mA		1.0 1.0	V V

SMALL SIGNAL CHARACTERISTICS

C _{ob}	Output Capacitance	V _{CB} = 10 V, f = 1.0 MHz		6.0	pF
f _T	Current Gain - Bandwidth Product	I _C = 10 mA, V _{CE} = 10 V, f = 100 MHz	100	400	
h _{fe}	Small-Signal Current Gain	I _C = 1.0 mA, V _{CE} = 10 V, f = 1.0 kHz	30	200	
NF	Noise Figure	V _{CE} = 5.0 V, I _C = 250 μA, R _S = 1.0 kΩ, f = 10 Hz to 15.7 kHz		8.0	V

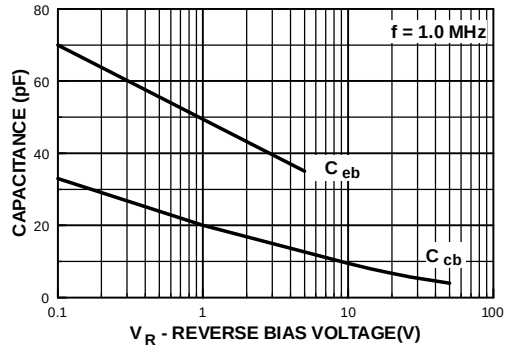
*Pulse Test: Pulse Width ≤ 300 ms, Duty Cycle ≤ 2.0%

Typical Characteristics

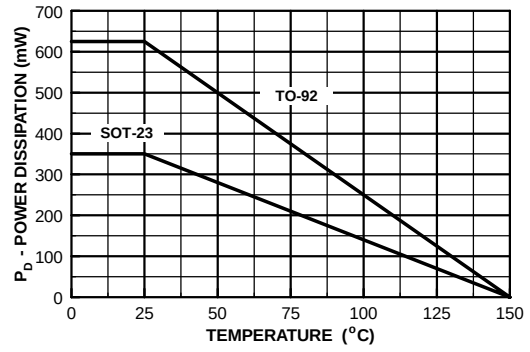


Typical Characteristics (continued)

Input and Output Capacitance
vs Reverse Voltage



Power Dissipation vs
Ambient Temperature



TO-92 Tape and Reel Data



TO-92 Packaging Configuration: Figure 1.0

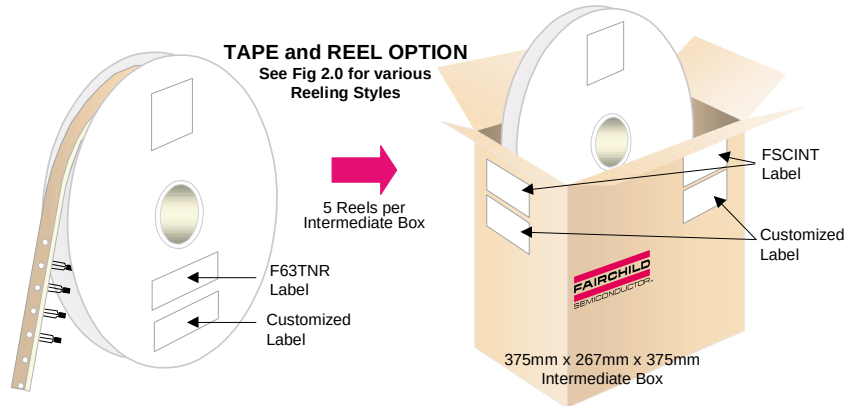
FSCINT Label sample



F63TNR Label sample



TAPE and REEL OPTION See Fig 2.0 for various Reeling Styles

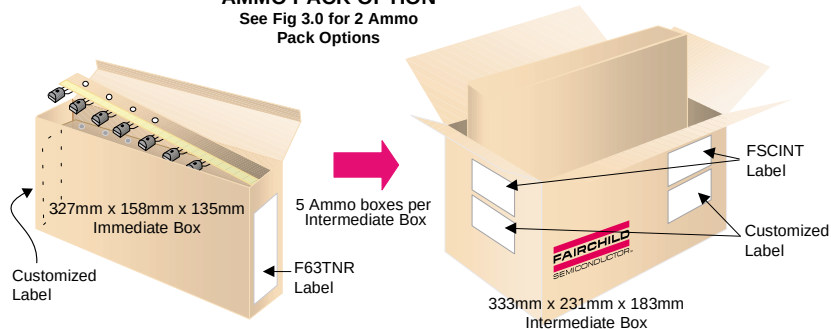


TO-92 TNR/AMMO PACKING INFORMATION

Packing	Style	Quantity	EOL code
Reel	A	2,000	D26Z
	E	2,000	D27Z
Ammo	M	2,000	D74Z
	P	2,000	D75Z

Unit weight = 0.22 gm
 Reel weight with components = 1.04 kg
 Ammo weight with components = 1.02 kg
 Max quantity per intermediate box = 10,000 units

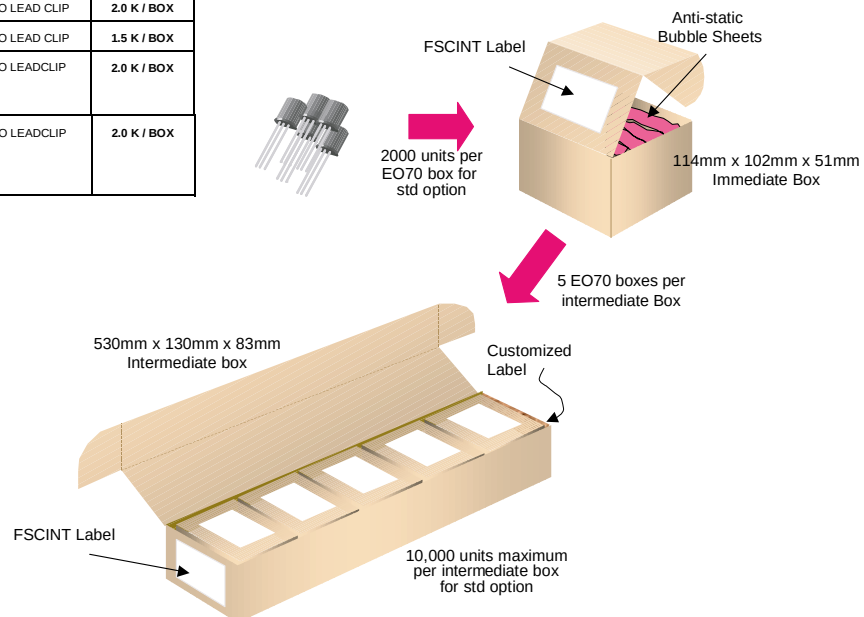
AMMO PACK OPTION See Fig 3.0 for 2 Ammo Pack Options



(TO-92) BULK PACKING INFORMATION

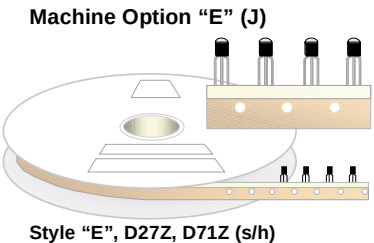
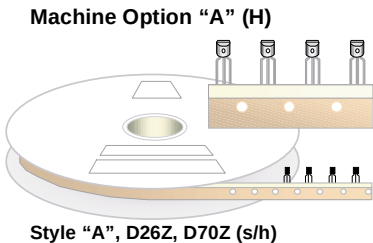
EOL CODE	DESCRIPTION	LEADCLIP DIMENSION	QUANTITY
J18Z	TO-18 OPTION STD	NO LEAD CLIP	2.0 K / BOX
J05Z	TO-5 OPTION STD	NO LEAD CLIP	1.5 K / BOX
NO EOL CODE	TO-92 STANDARD STRAIGHT FOR: PKG 92, 94 (NON PROELECTRON SERIES), 96	NO LEADCLIP	2.0 K / BOX
L34Z	TO-92 STANDARD STRAIGHT FOR: PKG 94 (PROELECTRON SERIES BCXXX, BFXXX, BSRXXX), 97, 98	NO LEADCLIP	2.0 K / BOX

BULK OPTION See Bulk Packing Information table

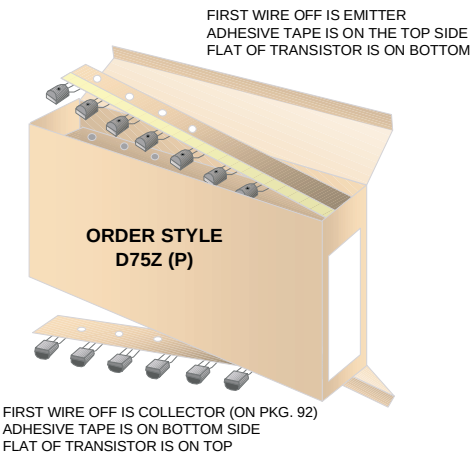
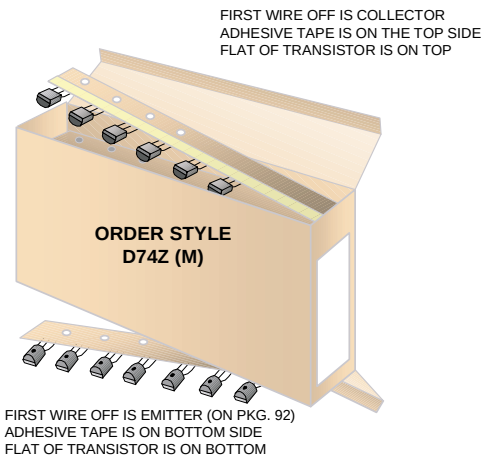


TO-92 Tape and Reel Data, continued

TO-92 Reeling Style Configuration: Figure 2.0

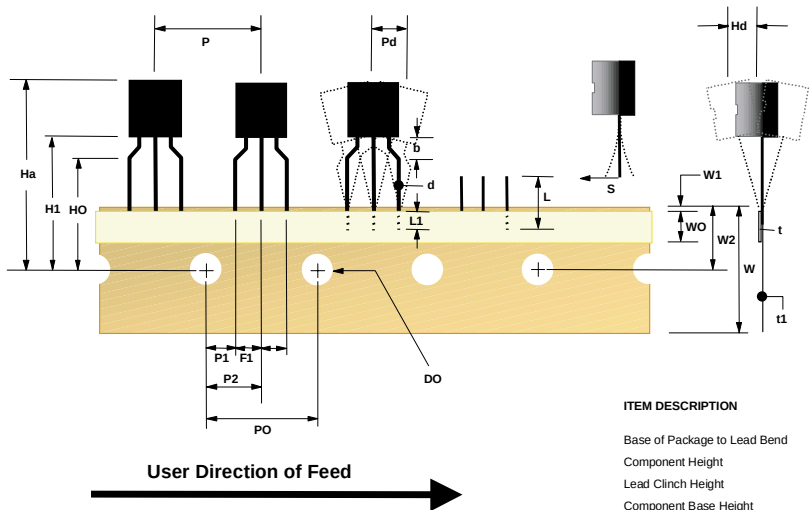


TO-92 Radial Ammo Packaging Configuration: Figure 3.0



TO-92 Tape and Reel Data, continued

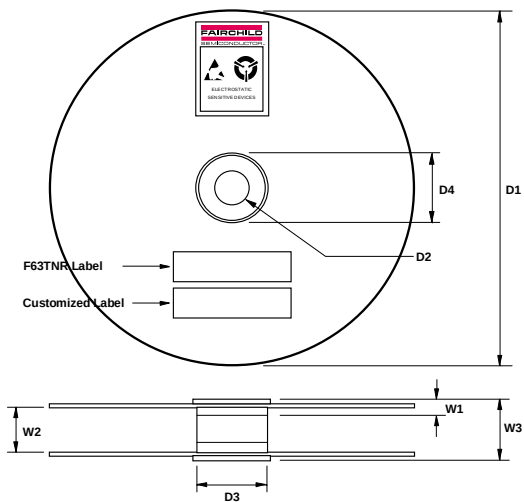
TO-92 Tape and Reel Taping Dimension Configuration: Figure 4.0



ITEM DESCRIPTION	SYMBOL	DIMENSION
Base of Package to Lead Bend	b	0.098 (max)
Component Height	Ha	0.928 (+/- 0.025)
Lead Clinch Height	HO	0.630 (+/- 0.020)
Component Base Height	H1	0.748 (+/- 0.020)
Component Alignment (side/side)	Pd	0.040 (max)
Component Alignment (front/back)	Hd	0.031 (max)
Component Pitch	P	0.500 (+/- 0.020)
Feed Hole Pitch	PO	0.500 (+/- 0.008)
Hole Center to First Lead	P1	0.150 (+0.009, -0.010)
Hole Center to Component Center	P2	0.247 (+/- 0.007)
Lead Spread	F1/F2	0.104 (+/- 0.010)
Lead Thickness	d	0.018 (+0.002, -0.003)
Cut Lead Length	L	0.429 (max)
Taped Lead Length	L1	0.209 (+0.051, -0.052)
Taped Lead Thickness	t	0.032 (+/- 0.006)
Carrier Tape Thickness	t1	0.021 (+/- 0.006)
Carrier Tape Width	W	0.708 (+0.020, -0.019)
Hold - down Tape Width	WO	0.236 (+/- 0.012)
Hold - down Tape position	W1	0.035 (max)
Feed Hole Position	W2	0.360 (+/- 0.025)
Sprocket Hole Diameter	DO	0.157 (+0.008, -0.007)
Lead Spring Out	S	0.004 (max)

Note : All dimensions are in inches.

TO-92 Reel Configuration: Figure 5.0



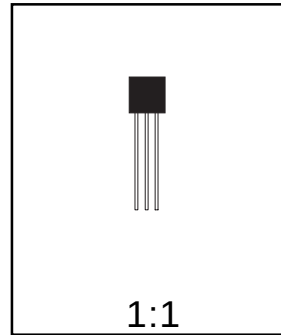
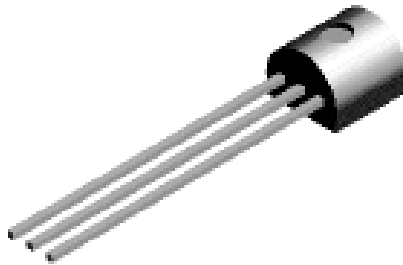
ITEM DESCRIPTION	SYMBOL	MINIMUM	MAXIMUM
Reel Diameter	D1	13.975	14.025
Arbor Hole Diameter (Standard)	D2	1.160	1.200
Arbor Hole Diameter (Small Hole)	D3	0.650	0.700
Core Diameter	D4	3.100	3.300
Hub Recess Inner Diameter	D5	2.700	3.100
Hub Recess Depth	D6	0.370	0.570
Flange to Flange Inner Width	W1	1.630	1.690
Hub to Hub Center Width	W2		2.090
Hub to Hub Center Width	W3		

Note: All dimensions are inches

TO-92 Package Dimensions



TO-92 (FS PKG Code 92, 94, 96)



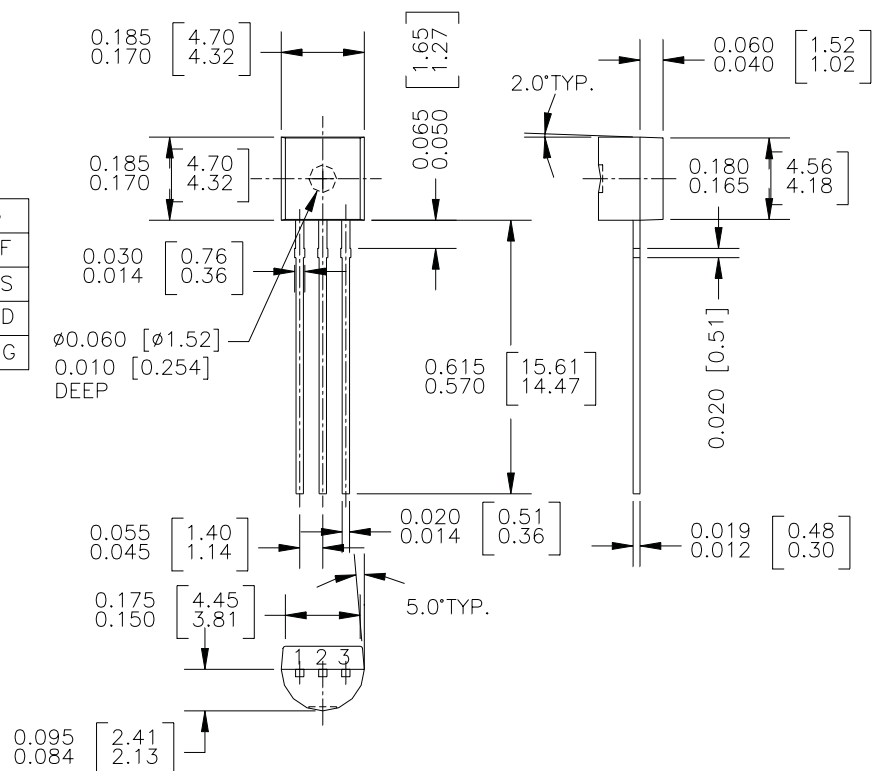
Scale 1:1 on letter size paper

Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.1977

TO-92 (92,94,96)

PIN	92		94		96	
	B	F	B	F	B	F
1	E	D	E	D	B	S
2	B	S	C	G	E	D
3	C	G	B	S	C	G



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